

Accepted Manuscript

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PII: S2352-4316(16)30216-4

DOI: <http://dx.doi.org/10.1016/j.eml.2016.11.008>

Reference: EML 240

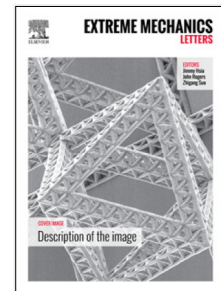
To appear in: *Extreme Mechanics Letters*

Received date: 11 October 2016

Accepted date: 6 November 2016

Please cite this article as: Y. Shi, F. Zhang, K. Nan, X. Wang, J. Wang, Y. Zhang, Y. Zhang, H. Luan, K.-C. Hwang, Y. Huang, J.A. Rogers, Y. Zhang, Plasticity-induced origami for assembly of three dimensional metallic structures guided by compressive buckling, *Extreme Mechanics Letters* (2016), <http://dx.doi.org/10.1016/j.eml.2016.11.008>

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